

# LTCC SURFACE MOUNT

# Bandpass Filter

**BFCN-2555+** 

50Ω

2500 to 2610 MHz

# **THE BIG DEAL**

- Good Rejection, 30 dB Typ.
- 1206 Surface Mount Footprint
- Power Handling: 1.5 Watts

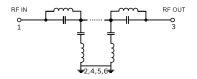


Generic photo used for illustration purposes only

# **APPLICATIONS**

- Harmonic Rejection
- · Transmitters / Receivers

# **FUNCTIONAL DIAGRAM**



# **PRODUCT OVERVIEW**

Mini-Circuits' BFCN-2555+ LTCC Band Pass Filter is constructed with multiple layers in order to achieve a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 110 MHz passband, these units offer low insertion loss and good rejection.

# **KEY FEATURES**

Features	Advantages
Small Size, 1206	Allows for high layout density of circuit boards, while minimizing the effects of parasitics.
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.
Rugged Power handling	Handles up to 1.5 Watts in a small package.

PAGE 1 OF 5



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# ELECTRICAL SPECIFICATIONS<sup>1,2</sup> AT +25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Units
	Center Frequency <sup>3</sup>	_	_	_	2555	_	MHz
Passband	Insertion Loss	F1-F2	2500 - 2610	_	_	7	dB
	Return Loss	F1-F2	2500 - 2610	6.49	12.74	_	dB
Stan Band Lawer	Rejection	DC-F3	DC - 1970	20	_	_	dB
Stop Band, Lower		F4	2000	_	30	_	
Char David Harris	Rejection	F5	3200	20	_	_	dB
Stop Band, Upper		F6-F7	3250 - 5500	_	30	_	ив

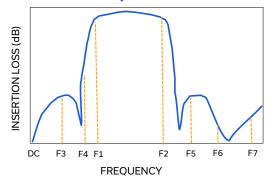
<sup>1.</sup> Tested in Evaluation Board P/N TB-BFCN-2555+.

# **ABSOLUTE MAXIMUM RATINGS<sup>4</sup>**

Parameter	Ratings
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
Input Power <sup>5</sup>	1.5W @25°C

<sup>4.</sup> Permanent damage may occur if any of these limits are exceeded.

# **TYPICAL FREQUENCY RESPONSE**



<sup>2.</sup> This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

<sup>3.</sup> Typical variation ± 5%

<sup>5.</sup> Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.25W at +100°C.

# LTCC SURFACE MOUNT

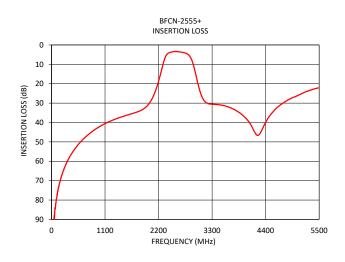
# Bandpass Filter

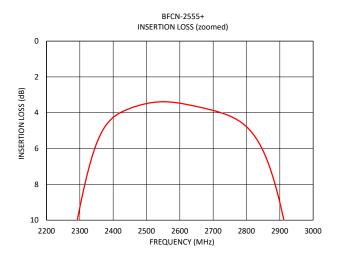
**BFCN-2555+** 

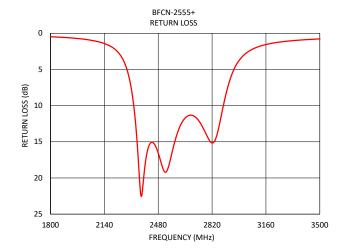
50Ω

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# **TYPICAL PERFORMANCE GRAPHS AT +25°C**









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# Bandpass Filter

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# **FUNCTIONAL DIAGRAM**

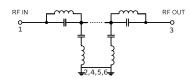
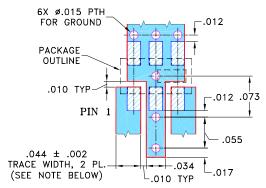


Figure 1. BFCN-2555+ Functional Diagram

# PAD DESCRIPTION

Function	Pad Number	Description
RF1 <sup>2</sup>	1	Connects to RF Input Port
RF2 <sup>2</sup> 3		Connects to RF Output Port
GROUND	2,4,5,6	Connects to Ground on PCB, (See drawing PL-158)

# **SUGGESTED PCB LAYOUT (PL-158)**



NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015".

COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH MAY NEED

FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

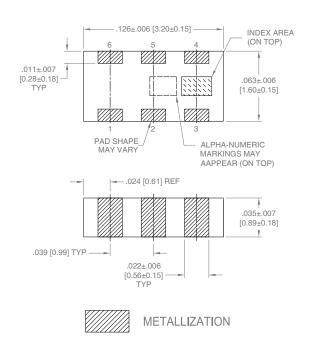
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Figure 2. Suggested PCB Layout PL-158

# **CASE STYLE DRAWING**



Weight: .020 grams.

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

# **PRODUCT MARKING\*: N/A**

\*Marking may contain other features or characters for internal lot control.



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# ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

**CLICK HERE** 

	Data
Performance Data & Graphs	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	FV1206-1 Lead Finish: Nickel Tin
RoHS Status	Compliant
Tape and Reel	TR-F75
Suggested Layout for PCB Design	PL-158
Evaluation Board	TB-BFCN-2555+
Evaluation Doal u	Gerber File
Environmental Rating	ENV06

### NOTES

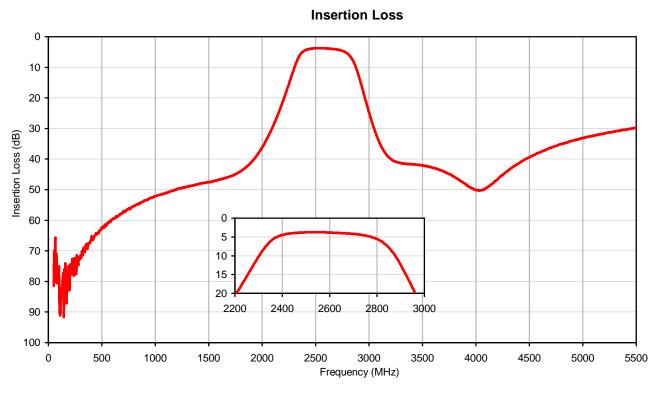
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
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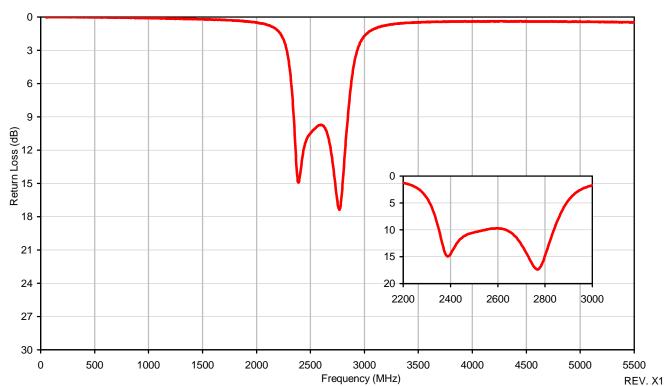
# Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
50	81.46	0.06
200	82.15	0.14
500	62.32	0.23
1000	52.18	0.31
1970	37.86	0.74
2000	36.18	0.80
2200	20.62	1.82
2300	10.23	5.06
2350	6.16	11.04
2500	3.78	18.11
2555	3.73	16.46
2610	3.87	12.77
2850	7.85	17.08
2920	14.80	5.83
3000	24.74	2.69
3200	39.85	1.20
3250	40.88	1.11
3700	44.06	0.74
4500	39.38	0.62
5500	29.82	0.63

# Typical Performance Curves



# Return Loss



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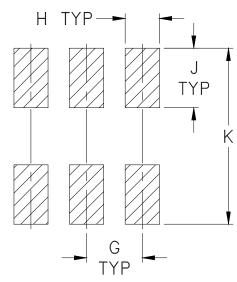
BFCN-2555+ 080219 Page 1 of 1

FV1206-1

# **Outline Dimensions**

# A±.006 INDEX AREA (ON TOP) F±.007 TYP PAD SHAPE MARKINGS MAY APPEAR (ON TOP) The part of the part o

# **PCB Land Pattern**



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	С	D	Е	F	G	Н	J	K	L	M	N	P	WT. GRAM
FV1206-1	.126 (3.20)	.063 (1.60)	.035 (0.89)	.024 (0.61)	.022 (0.56)	.011 (0.28)	.039 (0.99)	.024 (0.61)	.042 (1.07)	.123 (3.12)					.020

Dimensions are in inches (mm). Tolerances: 2 Pl. + .01; 3 Pl. + .005

# **Notes:**

- 1. Open style, ceramic base.
- 2. Termination finish: as shown below or indicated on Data Sheet.

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

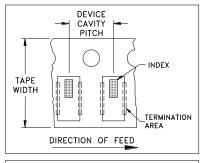
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

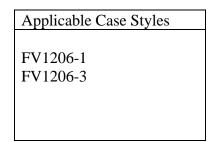
RFIIF MICROWAVE COMPONENTS

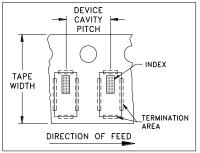
# Tape & Reel Packaging

# TR-F75

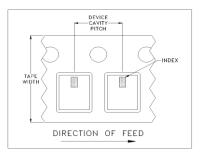
# **DEVICE ORIENTATION IN T&R**







Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9



A	pplicable Case Styles
F	V1206-12
G	E0805C-18
N	L1008C-6
N	L1008C-7
N	L1008C-9
N	L1008C-10

# **ILLUSTRATION 3**

ILLUSTRATION 1

ILLUSTRATION 2

Tape Width, mm	idth, mm Device Cavity Reel Size, Devices Pitch, mm inches			per Reel
			Small	20
			quantity	50
			standards	100
8	4	7	(see note)	200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits ISO 9001 & ISO 14001 Certified



INTERNET http://www.minicircuits.com

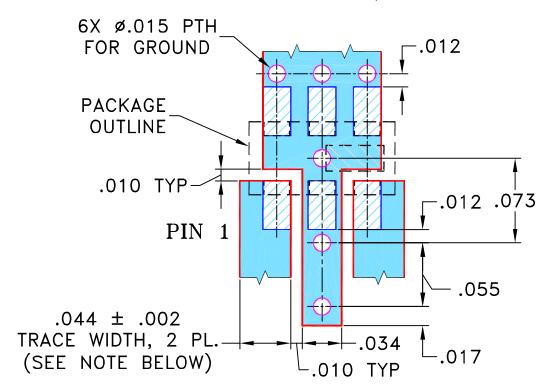
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THIRD AN	IGLE PROJECTION	
(h)		

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M92199	NEW RELEASE	05/24/04	ΑV	ABD
A	M99247	ADD GROUND PTH	06/05	RZ	RZ
A	R60782	ADD GROUND PTH	06/05	RZ	RZ
В	M102713	ADDED "WITH SMOBC"	01/12/06	GF	IL

# SUGGESTED MOUNTING CONFIGURATION FOR FV1206-1 CASE STYLE, "pr" PIN CONNECTION.



NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



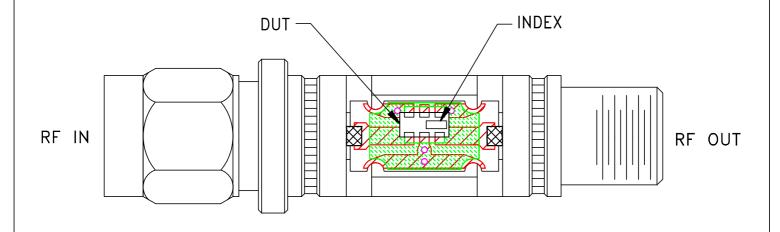
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



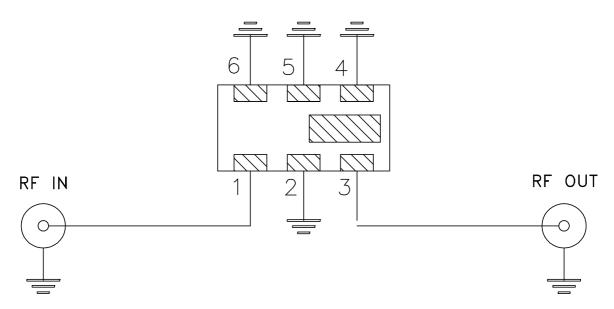
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED INITIALS		DATE								
DIMENSIONS ARE IN INCHES	DRAWN	ΑV	05/03/04	Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235						
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	IL	05/24/04							
3 PL DECIMALS ± .005	APPROVED	ABD	05/24/04	]						
FRACTIONS ±				PL, pr, FV1206-1, HFCN, TB-285						3-285
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						SCALE:		SHEET:	1	OT 1
	ASHEETA1.D	WG REV:A DA	ATE:01/12/95	<u></u> . 6	98PL158	00	12:1		1	OF 1

# Evaluation Board and Circuit



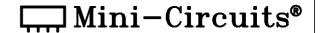
TB-285



Schematic Diagram

# Notes:

- 1. SMA Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.





# **Environmental Specifications**

ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec			
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet			
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet			
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours			
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1			
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage			
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D			
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A			

ENV06 Rev: A

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02/25/11

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